Quad 2-Input AND Gate

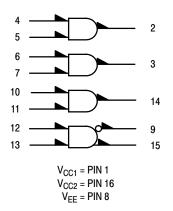
The MC10104 is a quad 2-input AND gate. One of the gates has both AND/NAND outputs available.

- $P_D = 35 \text{ mW typ/gate (No Load)}$
- $t_{pd} = 2.7 \text{ ns typ}$
- t_r , $t_f = 2.0$ ns typ (20%–80%)

ON Semiconductor

http://onsemi.com

LOGIC DIAGRAM







Pin assignment is for Dual-in-Line Package. For PLCC pin assignment, see the Pin Conversion Tables on page 18 of the ON Semiconductor MECL Data Book (DL122/D).

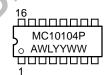
MARKING DIAGRAMS



CDIP-16 **L SUFFIX CASE 620** MC10104L **AWLYYWW**



PDIP-16 P SUFFIX **CASE 648**





PLCC-20 **FN SUFFIX CASE 775**



= Assembly Location

WL = Wafer Lot YY = Year

WW = Work Week

ORDERING INFORMATION

Device	Package	Shipping		
MC10104L	CDIP-16	25 Units / Rail		
MC10104P	PDIP-16	25 Units / Rail		
MC10104FN	PLCC-20	46 Units / Rail		

ELECTRICAL CHARACTERISTICS

				Test Limits							
Characteristic			Pin Under Test	−30°C		+25°C			+85°C		•
		Symbol		Min	Max	Min	Тур	Max	Min	Max	Unit
Power Supply	Drain Current	Ι _Ε	8		39			35		39	mAdc
Input Current		I _{inH} *	12 13		425 350			265 220		265 220	μAdc
		I _{inL}	12	0.5		0.5			0.3		μAdc
Output Voltage	e Logic 1	V _{OH}	15 9	-1.060 -1.060	-0.890 -0.890	-0.960 -0.960		-0.810 -0.810	-0.890 -0.890	-0.700 -0.700	Vdc
Output Voltage	e Logic 0	V _{OL}	15 9	-1.890 -1.890	-1.675 -1.675	-1.850 -1.850		-1.650 -1.650	-1.825 -1.825	-1.615 -1.615	Vdc
Threshold Vol	tage Logic 1	V _{OHA}	9 9 15 15	-1.090 -1.090 -1.090 -1.090		-0.980 -0.980 -0.980 -0.980			-0.910 -0.910 -0.910 -0.910	C	Vdc
Threshold Vol	tage Logic 0	V _{OLA}	9 9 15 15		-1.655 -1.655 -1.655 -1.655			-1.630 -1.630 -1.630 -1.630		-1.595 -1.595 -1.595 -1.595	Vdc
Switching Tim	es (50Ω Load)										ns
Propagation D	Delay	t ₁₂₊₁₅₊ t ₁₂₋₁₅₋ t ₁₂₊₉₋ t ₁₂₋₉₊	15 15 9 9	1.0 1.0 1.0 1.0	4.3 4.3 4.3 4.3	1.0 1.0 1.0 1.0	2.2 2.2 2.2 2.2	4.0 4.0 4.0 4.0	1.0 1.0 1.0 1.0	4.2 4.2 4.2 4.2	
		t ₁₃₊₁₅₊ t ₁₃₊₉₋	15 9	1.0	4.3 4.3	1,0 1.0	2.7 2.7	4.0 4.0	1.0 1.0	4.2 4.2	
Rise Time	(20 to 80%)	t ₁₅₊ t ₉₊	15 9	1.5 1.5	3.7 3.7	1.5 1.5	2.0 2.0	3.5 3.5	1.5 1.5	3.6 3.6	
Fall Time	(20 to 80%)	t ₁₅ _ t ₉ _	15 9	1.5 1.5	3.7 3.7	1.5 1.5	2.0 2.0	3.5 3.5	1.5 1.5	3.6 3.6	

^{*} Inputs 4, 7, 10 and 13 will behave similarly for ac and I_{inH} values. Inputs 5, 6, 11 and 12 will behave similarly for ac and I_{inH} values.

ELECTRICAL CHARACTERISTICS (continued)

					TEST VOI	TAGE VALU	JES (Volts)		
		@ Test Te	mperature	V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}	
			-30°C	-0.890	-1.890	-1.205	-1.500	-5.2	
			+25°C	-0.810	-1.850	-1.105	-1.475	-5.2	
			+85°C	-0.700	-1.825	-1.035	-1.440	-5.2	
			Pin	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					
Characteristic		Symbol	Under Test	V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}	(V _{CC}) Gnd
Power Supply Drain C	Current	ΙE	8					8	1, 16
Input Current		I _{inH*}	12 13	12, 13 13				8 8	1, 16 1, 16
		I _{inL}	12		12			8	1, 16
Output Voltage	Logic 1	V _{OH}	15 9	12, 13				8 8	1, 16 1, 16
Output Voltage	Logic 0	V _{OL}	15 9	12, 13				8 8	1, 16 1, 16
Threshold Voltage	Logic 1	V _{OHA}	9 9 15 15	12 13		13 12	12 13	8 8 8	1, 16 1, 16 1, 16 1, 16
Threshold Voltage	Logic 0	V _{OLA}	9 9 15 15	12 13	7/	13 12	12 13	8 8 8	1, 16 1, 16 1, 16 1, 16
Switching Times	(50Ω Load)			+1.11V		Pulse In	Pulse Out	-3.2 V	+2.0 V
Propagation Delay		t ₁₂₊₁₅₊ t ₁₂₋₁₅₋ t ₁₂₊₉₋ t ₁₂₋₉₊	15 15 9 9	13 13 13 13	(O)	12 12 12 12	15 15 9 9	8 8 8	1, 16 1, 16 1, 16 1, 16
		t ₁₃₊₁₅₊ t ₁₃₊₉₋	15 9	12 12		13 13	15 9	8 8	1, 16 1, 16
Rise Time	(20 to 80%)	t ₁₅₊ t ₉₊	15 9	12 12		13 13	15 9	8 8	1, 16 1, 16
Fall Time	(20 to 80%)	t ₁₅₋	15 9	12 12		13 13	15 9	8 8	1, 16 1, 16

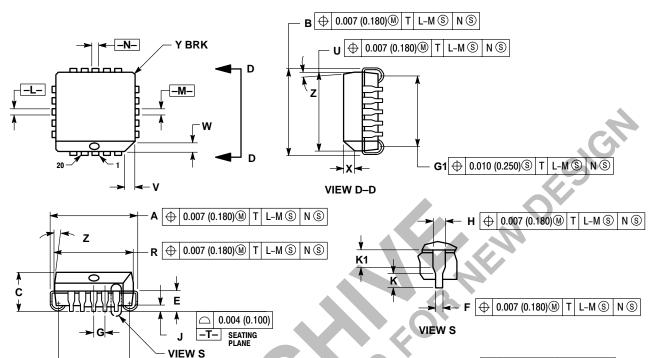
^{*} Inputs 4, 7, 10 and 13 will behave similarly for ac and I_{inH} values. Inputs 5, 6, 11 and 12 will behave similarly for ac and I_{inH} values.

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to –2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

PACKAGE DIMENSIONS

PLCC-20 **FN SUFFIX**

PLASTIC PLCC PACKAGE CASE 775-02 ISSUE C



NOTES:

G1 ⊕ 0.010 (0.250)③ T L-M ⑤ N ⑤

OF VICE NOT PRESCO

- IOTES:

 1. DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.

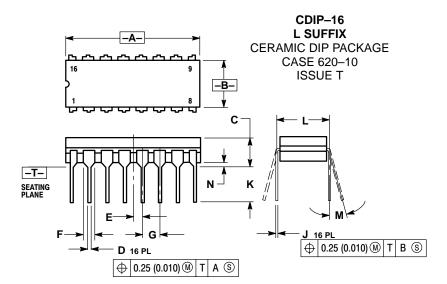
 2. DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.

 3. DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.

 4. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M. 1982.
- Y14.5M, 1982. 5. CONTROLLING DIMENSION: INCH.
- THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY
- EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY. DIMENSION H DOES NOT INCLUDE DAMBAR
- PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

	INC	HES	MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.385	0.395	9.78	10.03	
В	0.385	0.395	9.78	10.03	
С	0.165	0.180	4.20	4.57	
Е	0.090	0.110	2.29	2.79	
F	0.013	0.019	0.33	0.48	
G	0.050	BSC	1.27 BSC		
Н	0.026	0.032	0.66	0.81	
J	0.020		0.51		
K	0.025		0.64		
R	0.350	0.356	8.89	9.04	
U	0.350	0.356	8.89	9.04	
٧	0.042	0.048	1.07	1.21	
W	0.042	0.048	1.07	1.21	
X	0.042	0.056	1.07	1.42	
Y		0.020		0.50	
Z	2°	10°	2 °	10 °	
G1	0.310	0.330	7.88	8.38	
K1	0.040		1.02		

PACKAGE DIMENSIONS



NOTES:

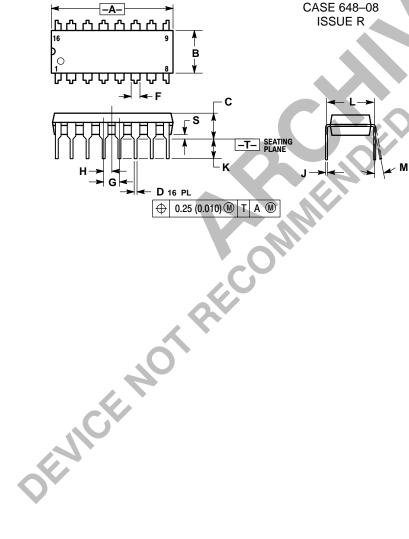
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: INCH.
 DIMENSION LTO CENTER OF LEAD WHEN CONTROLLING DIMENSION LTO CENTER OF LEAD WHEN

- FORMED PARALLEL

 DIMENSION F MAY NARROW TO 0.76 (0.030)
 WHERE THE LEAD ENTERS THE CERAMIC
 BODY.

	INC	HES	MILLIN	IETERS	
DIM	MIN	MIN MAX		MAX	
Α	0.750	0.785	19.05	19.93	
В	0.240	0.295	6.10	7.49	
С		0.200		5.08	
D	0.015	0.020	0.39	0.50	
E	0.050	BSC	1.27 BSC		
F	0.055	0.065	1.40	1.65	
G	0.100	BSC	2.54 BSC		
Н	0.008	0.015	0.21	0.38	
K	0.125	0.170	3.18	4.31	
L	0.300	BSC	7.62	BSC	
M	0 °	15°	0 °	15°	
N	0.020	0.040	0.51	1.01	

PDIP-16 **P SUFFIX** PLASTIC DIP PACKAGE CASE 648-08 ISSUE R



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
 5. ROUNDED CORNERS OPTIONAL

	INC	HES	MILLIN	IETERS	
DIM	MIN MAX		MIN	MAX	
Α	0.740	0.770	18.80	19.55	
В	0.250	0.270	6.35	6.85	
C	0.145	0.175	3.69	4.44	
D	0.015	0.021	0.39	0.53	
F	0.040	0.70	1.02	1.77	
G	0.100	BSC	2.54 BSC		
Н	0.050	BSC	1.27 BSC		
J	0.008	0.015	0.21	0.38	
K	0.110	0.130	2.80	3.30	
L	0.295	0.305	7.50	7.74	
M	0°	10°	0°	10 °	
S	0.020	0.040	0.51	1.01	

Notes



Notes





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